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To the Honorable Commissioner of Patents and Trademarks

Please record the attached original documents or copy thereof

JCS11 U.S. PTO
09/23/99
01/13/99

1. Name of conveying party(ies): Dean A. Klein and
Michael V. Leman

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: MICRON ELECTRONICS, INC.

Internal Address:

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date:

Street Address: 900 East Karcher Road

City: Nampa State: Idaho Zip: 83687

Additional name(s) and address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No

09231,306

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Hoyt A. Fleming, III

Internal Address: Patent Dept., Mail Stop 820

MICRON ELECTRONICS, INC.

Street Address: 900 East Karcher Road

City: Nampa State: Idaho Zip: 83687

6. Total number of application and patents involved: 1

7. Total fee (37 CFR 3.41) \$ 40.00

☐ Enclosed

X Authorized to be charged to deposit account

8. Deposit account number:

500659 ✓

(Attach duplicate copy of this page if paying by deposit account)

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Hoyt A. Fleming, III

Name of Person Signing

Hoyt A. Fleming, III
Signature

Date

Total number of pages including cover sheet, attachments, and document: 3

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1-1-99 JMW/KMS
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PATENT
REEL: 9709 FRAME: 0798

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| | | |
|------------------------------------|---|-------------------------|
| In re application of: | § | |
| Dean A. Klein and Michael V. Leman | § | Group Art Unit: Unknown |
| | § | |
| Serial No.: Unknown | § | Examiner: Unknown |
| | § | |
| Filed: Concurrently herewith | § | Atty. Docket: 98.02860 |
| | § | |
| For: CIRCUIT BOARD GROUNDING AND | § | |
| SUPPORT STRUCTURE APPARATUS AND | § | |
| METHOD | § | |
| | § | |

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, do hereby:

SELL, ASSIGN AND TRANSFER to MICRON ELECTRONICS, INC., (the "Assignee"), a corporation of Minnesota having a place of business at 900 East Karcher Road, Nampa, ID 83687 the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled: "**Circuit Board Grounding And Support Structure Apparatus and Method**" such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

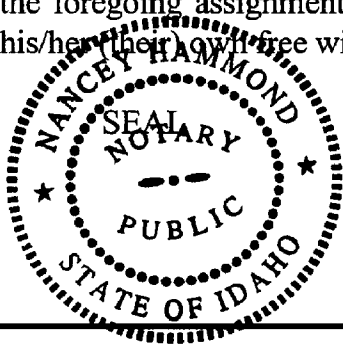
COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

(Signature) Dean A. Klein Date: 1/4/99
Dean A. Klein

STATE OF IDAHO)
) ss.
County of Canyon)

BEFORE ME, this 4th day of January 1999 personally appeared the above-named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she (they) executed the same of his/her (their) own free will for the purpose therein expressed.

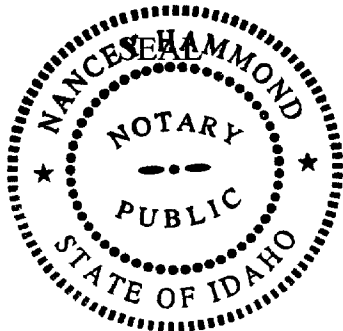


Nancy Hammond
Notary or Consular Officer
My Commission Expires: 6/12/03

(Signature) Michael V. Leman Date: 1/4/99
Michael V. Leman

STATE OF IDAHO)
) ss.
County of Canyon)

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Nancy Hammond
Notary or Consular Officer
My Commission Expires: 6/12/03